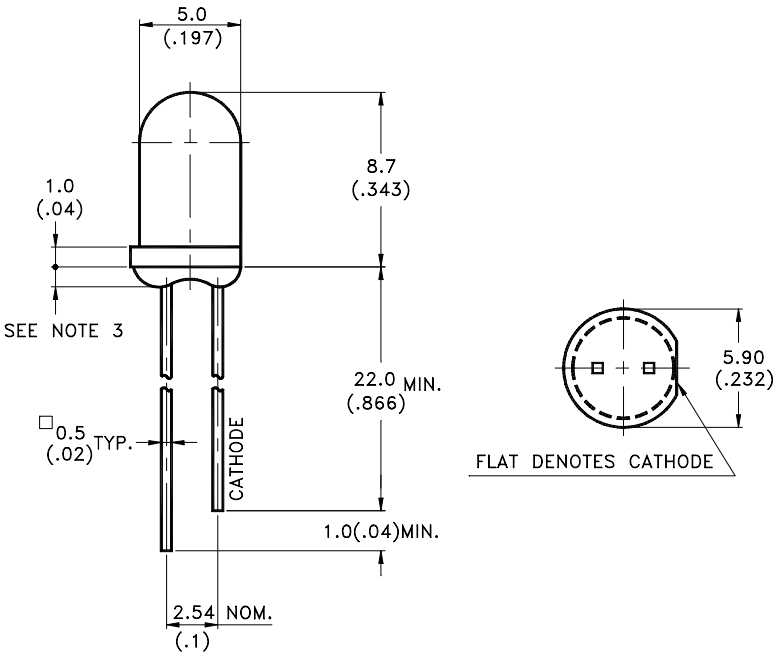
Features

* High luminous intensity output.
* Low power consumption.
* High efficiency.
* Versatile mounting on P.C. board or panel.
* I.C. Compatible/low current requirements.
* Popular T-1 3/4 diameter.

Package Dimensions



Part No.	Lens	Source Color
LTL2P3KEK-012A	Water Clear	AlInGaP Red

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25mm(.010") unless otherwise noted.
3. Protruded resin under flange is 1.0mm(.04") max.
4. Lead spacing is measured where the leads emerge from the package.
5. Specifications are subject to change without notice.

Absolute Maximum Ratings at TA=25℃

Parameter	Maximum Rating	Unit
Power Dissipation	75	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	90	mA
Continuous Forward Current	30	mA
Derating Linear From 50℃	0.4	mA/℃
Reverse Voltage	5	V
Operating Temperature Range	-40℃ to + 100℃	
Storage Temperature Range	-55℃ to + 100℃	
Lead Soldering Temperature [1.6mm(.063") From Body]	260℃ for 5 Seconds	

Electrical / Optical Characteristics at T_A=25℃

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I_V	310	1000		mcd	I_F = 20mA Note 1,5
Viewing Angle	$2\theta_{1/2}$		22		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λ_P		632		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ_d		624		nm	Note 4
Spectral Line Half-Width	$\Delta\lambda$		20		nm	
Forward Voltage	V_F		2.05	2.4	V	I_F = 20mA
Reverse Current	I_R			100	μA	V_R = 5V
Capacitance	C		40		pF	V_F = 0 , f = 1MHz

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. Iv classification code is marked on each packing bag.
4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
5. The Iv guarantee should be added ±15%.

Typical Electrical / Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

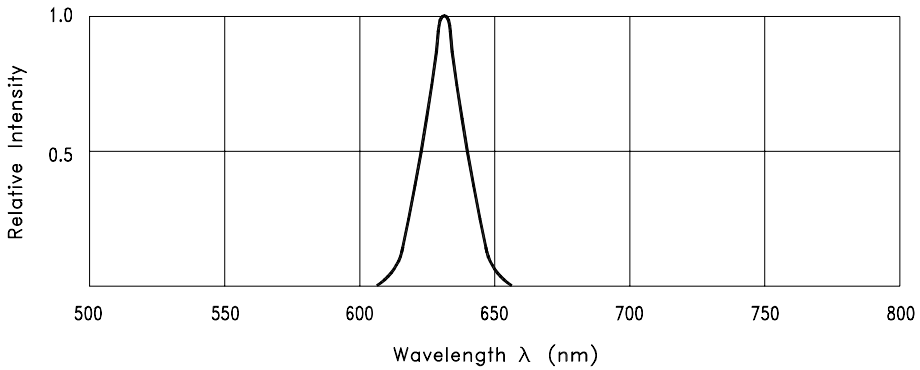


Fig.1 Relative Intensity vs. Wavelength

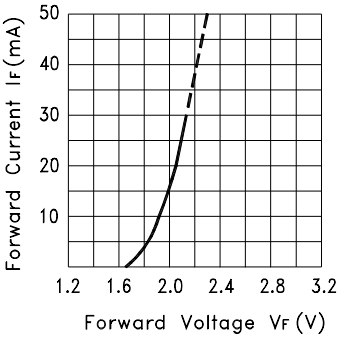


Fig.2 Forward Current vs. Forward Voltage

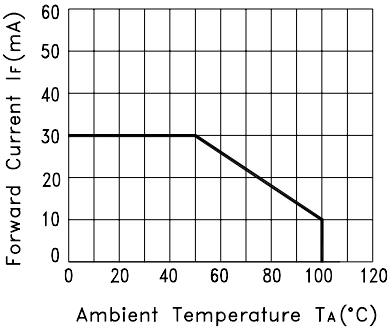


Fig.3 Forward Current Derating Curve

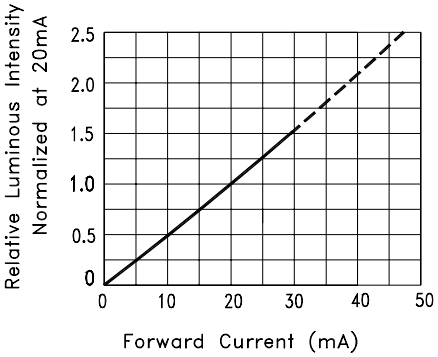


Fig.4 Relative Luminous Intensity vs. Forward Current

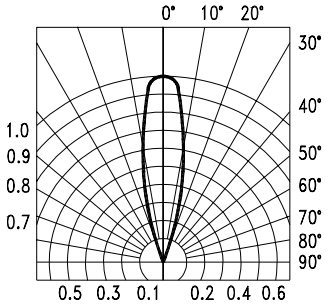
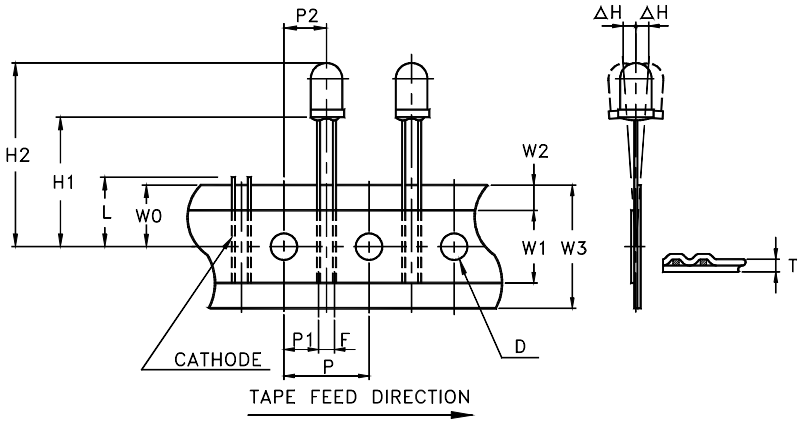


Fig.5 Spatial Distribution

Features

* Compatible with radial lead automatic insertion equipment.
* Most radial lead plastic lead lamps available packaged in tape and folding.
* 2.54mm (0.1") straight lead spacing available.
* Folding packaging simplifies handling and testing.
  Reel packaging is available by removing suffix “A” on option.

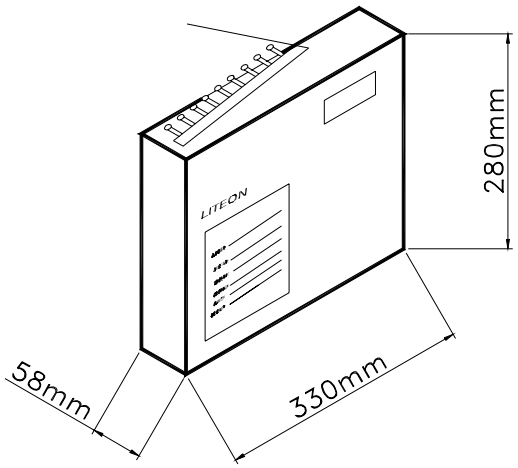
Package Dimensions



Item	Symbol	Specification			
		Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	2.3	0.091	3.0	0.118
Front to Rear Deflection	△H	--	--	2.0	0.078
Feed Hole to Bottom of Component	H1	21.5	0.846	22.5	0.886
Feed Hole to Overall Component Height	H2	29.9	1.177	31.5	1.240
Lead Length After Component Height	L	W0		11.0	0.433
Feed Hole Pitch	P	12.4	0.488	13.0	0.511
Lead Location	P1	4.4	0.173	5.8	0.228
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Tape Thickness	T	--	--	0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748

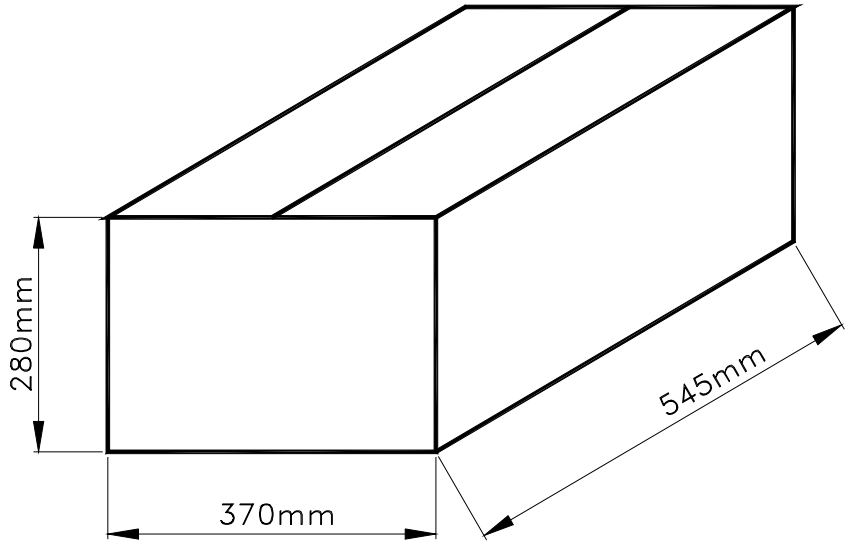
Packing Spec

2000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton
total 20000 pcs per outer carton



Bin Code List For Reference

Luminous Intensity Iv(mcd) IF@20mA		
Bin Code	Min.	Max.
K	310	400
L	400	520
M	520	680
N	680	880
P	880	1150
Q	1150	1500

Dominant Wavelength λd(nm) IF@20mA		
Bin Code	Min.	Max.
H27	613.5	617.0
H28	617.0	621.0
H29	621.0	625.0
H30	625.0	629.0
H31	629.0	633.0